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1. CORRESPONDENCE ADDRESS		2. INVENTOR(S) ADDRESS CHANGE (Complete only if there is a change)	
34M1/0928 MERCHANT GOULD SMITH EDELL WELTER & SCHMIDT 3100 NORWEST CENTER MINNEAPOLIS MN 55402-4131		INVENTOR'S NAME Street Address City, State and Zip Code CO-INVENTOR'S NAME Street Address City, State and Zip Code <input type="checkbox"/> Check if additional changes are enclosed	
APPLICATION NO.	FILING DATE	TOTAL CLAIMS	EXAMINER AND GROUP ART UNIT
08/804,547	02/24/97	003	FLANIGAN, A
DATE MAILED			
09/23/97			
First Named Applicant	CHI H HSIEN		

TITLE OF INVENTION: HEAT SINK HAVING AN ASSEMBLING DEVICE

\$660

ATTY'S DOCKET NO.	CLASS-SUBCLASS	BATCH NO.	APPLN. TYPE	SMALL ENTITY	FEE DUE	DATE DUE
3	9751.46US01	165-080.300	S05	UTILITY	YES	\$645.00 12/23/97

3. Correspondence address change (Complete only if there is a change) 01/21/1998 LBERGER 00000010 08804547 01 FC:242 660.00 OP 02 FC:561 33.00 OP	4. For printing on the patent front page, list the names of not more than 3 registered patent attorneys or agents OR, alternatively, the name of a firm having as a member a registered attorney or agent. If no name is listed, no name will be printed. 1 Merchant, Gould, 2 Smith, Edell, Welter 3 & Schmidt, P.A.
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5. ASSIGNMENT DATA TO BE PRINTED ON THE PATENT (print or type)		6a. The following fees are enclosed: <input checked="" type="checkbox"/> Issue Fee <input checked="" type="checkbox"/> Advance Order - # of Copies 11 6b. The following fees should be charged to: DEPOSIT ACCOUNT NUMBER 13-2725 (ENCLOSE A COPY OF THIS FORM) <input type="checkbox"/> Issue Fee <input type="checkbox"/> Advance Order - # of Copies <input checked="" type="checkbox"/> Any Deficiencies in Enclosed Fees	
(1) NAME OF ASSIGNEE: Silicon Integrated Systems Corporation (2) ADDRESS (CITY & STATE OR COUNTRY): Hsinchu, Taiwan R.O.C.		The COMMISSIONER OF PATENTS AND TRADEMARKS is requested to apply the Issue Fee to the application identified above. (Authorized Signature) <i>[Signature]</i> (Date) 12/18/97 NOTE: The Issue Fee will not be accepted from anyone other than the applicant, a registered attorney or agent, or the assignee or other party in interest as shown by the records of the Patent and Trademark Office.	

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on: December 18, 1997 (Date)
 Michael D. Schumann (Name of person making deposit)
[Signature] (Signature)
 12/18/97 (Date)